



**THE DATASHEET OF  
VJ1210Y473KXBAT**





## Surface Mount Multilayer Ceramic Chip Capacitors for Automotive Applications



### FEATURES

- AEC-Q200 qualified with PPAP available
- Available in 0402 to 1812 body size
- High operating temperature
- Wet build process
- Reliable Noble Metal Electrode (NME) system
- Parts compliant with ELV directive
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

For more than 30 years Vishay Vitramon has supported the automotive industry with robust, highly reliable MLCCs that have made it a leader in this segment. All Vishay Vitramon MLCCs are manufactured in “Precious Metal Technology” (PMT / NME) and a wet build process. They are qualified according to AEC-Q200 with PPAP available on request. Applications for these devices include automotive “under the hood”, safety and comfort electronics. Their termination finish is 100 % matte tin plate finish. A polymer (flexible) termination with 100 % matte tin plate finish is offered for boardflex sensitive applications.

### COG (NP0) DIELECTRIC

#### GENERAL SPECIFICATION

##### Note

Electrical characteristics at +25 °C unless otherwise specified

**Operating Temperature:** -55 °C to +150 °C  
(above +125 °C changed characteristics, see 2.2)

**Capacitance Range:** 22 pF to 22 nF

**Voltage Range:** 25 V<sub>DC</sub> to 3000 V<sub>DC</sub>

**Temperature Coefficient of Capacitance (TCC):**  
0 ppm/°C ± 30 ppm/°C from -55 °C to +125 °C

##### Dissipation Factor (DF):

0.1 % maximum at 1.0 V<sub>RMS</sub> and  
1 MHz for values ≤ 1000 pF  
0.1 % maximum at 1.0 V<sub>RMS</sub> and  
1 kHz for values > 1000 pF

##### Insulating Resistance:

at +25 °C 100 000 MΩ min. or 1000 ΩF whichever is less  
at +125 °C 10 000 MΩ min. or 100 ΩF whichever is less

**Aging:** 0 % maximum per decade

##### Dielectric Strength Test:

performed per method 103 of EIA 198-2-E.

Applied test voltages

≤ 250 V <sub>DC</sub> -rated:	250 % of rated voltage
500 V <sub>DC</sub> -rated:	200 % of rated voltage
630 V <sub>DC</sub> , 1000 V <sub>DC</sub> -rated:	150 % of rated voltage
3000 V <sub>DC</sub> -rated:	120 % of rated voltage

### X7R, X8R DIELECTRIC

#### GENERAL SPECIFICATION

##### Note

Electrical characteristics at +25 °C unless otherwise specified

**Operating Temperature:** -55 °C to +150 °C  
(X7R above +125 °C changed characteristics, see 2.2)

**Capacitance Range:** 120 pF to 1.0 μF

**Voltage Range:** 16 V<sub>DC</sub> to 1000 V<sub>DC</sub>

##### Temperature Coefficient of Capacitance (TCC):

X7R: ± 15 % from -55 °C to +125 °C, with 0 V<sub>DC</sub> applied  
X8R: ± 15 % from -55 °C to +150 °C, with 0 V<sub>DC</sub> applied

##### Dissipation Factor (DF):

16 V, 25 V ratings: 3.5 % maximum at 1.0 V<sub>RMS</sub> and 1 kHz  
> 25 V ratings: 2.5 % maximum at 1.0 V<sub>RMS</sub> and 1 kHz

##### Insulating Resistance:

at +25 °C 100 000 MΩ min. or 1000 ΩF whichever is less  
at +125 °C 10 000 MΩ min. or 100 ΩF whichever is less  
X8R: at +150 °C 10 000 MΩ min. or 100 ΩF whichever is less

**Aging Rate:** 1 % maximum per decade

##### Dielectric Strength Test:

performed per method 103 of EIA 198-2-E.

Applied test voltages

≤ 250 V <sub>DC</sub> -rated:	250 % of rated voltage
500 V <sub>DC</sub> -rated:	min. 150 % of rated voltage
630 V <sub>DC</sub> , 1000 V <sub>DC</sub> -rated:	min. 120 % of rated voltage



QUICK REFERENCE DATA				
DIELECTRIC	CASE CODE	MAXIMUM VOLTAGE (V)	CAPACITANCE	
			MINIMUM	MAXIMUM
C0G (NP0)	0402	100	22 pF	220 pF
	0603	200	56 pF	1.0 nF
	0805	500	100 pF	3.9 nF
	1206	630	100 pF	8.2 nF
	1210	630	100 pF	12 nF
	1812	3000	33 pF	22 nF
X7R	0402	100	120 pF	33 nF
	0603	200	330 pF	150 nF
	0805	250	330 pF	470 nF
	1206	1000	220 pF	1.0 μF
	1210	630	390 pF	1.0 μF
	1812	630	10 nF	1.0 μF
X8R	0402	100	330 pF	6.8 nF
	0603	100	470 pF	33 nF
	0805	100	470 pF	100 nF
	1206	50	1.0 nF	220 nF
	1210	50	10 nF	220 nF

**Note**

- Detail ratings see “Selection Chart”



ORDERING INFORMATION - TIN TERMINATION								
VJ0805	Y	102	K	X	A	B	C	31X
CASE CODE	DIELECTRIC	CAPACITANCE NOMINAL CODE	CAPACITANCE TOLERANCE	TERMINATION	DC VOLTAGE RATING <sup>(1)</sup>	MARKING <sup>(3)</sup>	PACKAGING	PROCESS CODE
0402 0603 0805 1206 1210 1812	A = COG (NP0) Y = X7R H = X8R	Expressed in picofarads (pF). The first two digits are significant, the third is a multiplier. An "R" indicates a decimal point. <b>Examples</b> 4R7 = 4.7 pF 102 = 1000 pF	B = ± 0.10 pF C = ± 0.25 pF D = ± 0.5 pF F = ± 1 % G = ± 2 % J = ± 5 % K = ± 10 % M = ± 20 % <b>Note</b> COG (NP0): B, C, D < 10 pF F, G, J, K ≥ 10 pF X7R / X8R: J, K, M	X = Ni barrier 100 % matte tin plate finish B = polymer 100 % matte tin plate finish <sup>(2)</sup>	J = 16 V X = 25 V A = 50 V B = 100 V C = 200 V P = 250 V E = 500 V L = 630 V G = 1000 V H = 3000 V	A = unmarked B = marked <b>Note</b> Marking for 0805 and 1206 vendor ID and date code	T = 7" reel / plastic tape C = 7" reel / paper tape R = 11 1/4" / 13" reel / plastic tape P = 11 1/4" / 13" reel / paper tape	31X = Automotive MLCC RoHS conform

**Notes**

- (1) DC voltage rating should not be exceeded in application. Other application factors may affect the MLCC performance. Consult for questions: [mlcc@vishay.com](mailto:mlcc@vishay.com)
- (2) Polymer termination contact [mlcc@vishay.com](mailto:mlcc@vishay.com) for availability of ratings. Packaging only in plastic tape "T" / "R"
- (3) No marking on 1206 size - 1000 V

DIMENSIONS in inches (millimeters)						
CASE CODE	STYLE	LENGTH (L)	WIDTH (W)	MAXIMUM THICKNESS (T)	TERMINATIONS PAD (P)	
					MINIMUM	MAXIMUM
0402	VJ0402	0.040 + 0.004 / - 0.002 (1.00 + 0.10 / - 0.05)	0.020 + 0.004 / - 0.002 (0.50 + 0.10 / - 0.05)	0.024 (0.60)	0.004 (0.10)	0.016 (0.41)
0603	VJ0603	0.063 ± 0.006 (1.60 ± 0.15)	0.031 ± 0.006 (0.80 ± 0.15)	0.038 (0.97)	0.012 (0.30)	0.018 (0.46)
0805	VJ0805	0.079 ± 0.008 (2.00 ± 0.20)	0.049 ± 0.008 (1.25 ± 0.20)	0.057 (1.45)	0.010 (0.25)	0.028 (0.71)
1206	VJ1206	0.126 ± 0.010 (3.20 ± 0.25)	0.063 ± 0.010 (1.60 ± 0.25)	0.067 (1.70)	0.010 (0.25)	0.028 (0.71)
1210	VJ1210	0.126 ± 0.010 (3.20 ± 0.25)	0.098 ± 0.010 (2.50 ± 0.25)	0.076 (1.94)	0.010 (0.25)	0.028 (0.71)
1812	VJ1812	0.177 ± 0.010 (4.50 ± 0.25)	0.126 ± 0.010 (3.20 ± 0.25)	0.086 (2.18)	0.010 (0.25)	0.030 (0.76)

**Note**

- Polymer (B-termination) have increased dimensions: part length increased by 0.006" (0.15 mm)



SELECTION CHART											
DIELECTRIC		COG (NP0)									
STYLE		VJ0402			VJ0603			VJ0805			
CASE CODE		0402			0603			0805			
VOLTAGE (V <sub>DC</sub> )		25	50	100	50	100	200	50	100	200	500
VOLTAGE CODE		X	A	B	A	B	C	A	B	C	E
CAP. CODE	CAP.										
1R0	1.0 pF										
1R2	1.2 pF										
1R5	1.5 pF										
1R8	1.8 pF										
2R2	2.2 pF										
2R7	2.7 pF										
3R3	3.3 pF										
3R9	3.9 pF										
4R7	4.7 pF										
5R6	5.6 pF										
6R8	6.8 pF										
8R2	8.2 pF										
100	10 pF										
120	12 pF										
150	15 pF										
180	18 pF										
220	22 pF	••	••	••							
270	27 pF	••	••	••							
330	33 pF	••	••	••							
390	39 pF	••	••	••							
470	47 pF	••	••	••							
560	56 pF	••	••	••	••	••	••				
680	68 pF	••	••	••	••	••	••				
820	82 pF	••	••	••	••	••	••				
101	100 pF	••	••	••	••	••	••	••	••	••	••
121	120 pF	••	••	••	••	••	••	••	••	••	••
151	150 pF	••	••		••	••	••	••	••	••	••
181	180 pF	••	••		••	••	•	••	••	••	••
221	220 pF	••	••		••	••	•	••	••	••	•
271	270 pF				••	••	•	••	••	••	•
331	330 pF				••	••		••	••	••	•
391	390 pF				••	••		••	••	••	•
471	470 pF				••	••		••	••	•	•
561	560 pF				••			••	••	•	
681	680 pF				••			••	••	•	
821	820 pF				••			••	••	•	
102	1.0 nF				••			••	••	•	
122	1.2 nF							••	•		
152	1.5 nF							••	•		
182	1.8 nF							•	•		
222	2.2 nF							•			
272	2.7 nF							•			
332	3.3 nF							•			
392	3.9 nF							•			
472	4.7 nF										
562	5.6 nF										
682	6.8 nF										
822	8.2 nF										
103	10 nF										
123	12 nF										
153	15 nF										
183	18 nF										
223	22 nF										
273	27 nF										
333	33 nF										
393	39 nF										
473	47 nF										
563	56 nF										

**Notes**

•• Paper tape, • Plastic tape

- For soldering conditions see Vishay Soldering Recommendations [www.vishay.com/doc?45034](http://www.vishay.com/doc?45034)

(1) Alternative product see GA...31M, GA...34G Automotive HIFREQ Series [www.vishay.com/doc?45248](http://www.vishay.com/doc?45248)



SELECTION CHART																			
DIELECTRIC		COG (NP0)																	
STYLE		VJ1206						VJ1210					VJ1812						
CASE CODE		1206						1210					1812						
VOLTAGE (V <sub>DC</sub> )		50	100	200	250	500	630	50	100	200	500	630	50	100	200	500	630	1000	3000
VOLTAGE CODE		A	B	C	P	E	L	A	B	C	E	L	A	B	C	E	L	G	H
CAP. CODE	CAP.																		
1R0	1.0 pF																		
1R2	1.2 pF																		
1R5	1.5 pF																		
1R8	1.8 pF																		
2R2	2.2 pF																		
2R7	2.7 pF																		
3R3	3.3 pF																		
3R9	3.9 pF																		
4R7	4.7 pF																		
5R6	5.6 pF																		
6R8	6.8 pF																		
8R2	8.2 pF																		
100	10 pF				(1)														
120	12 pF																		
150	15 pF																		
180	18 pF																		
220	22 pF																		
270	27 pF																		
330	33 pF																		
390	39 pF																		
470	47 pF																		
560	56 pF																		
680	68 pF																		
820	82 pF																		
101	100 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
121	120 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
151	150 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
181	180 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
221	220 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
271	270 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
331	330 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
391	390 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
471	470 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
561	560 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
681	680 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
821	820 pF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
102	1.0 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
122	1.2 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
152	1.5 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
182	1.8 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
222	2.2 nF	•	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•
272	2.7 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
332	3.3 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
392	3.9 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
472	4.7 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
562	5.6 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
682	6.8 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
822	8.2 nF	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	•
103	10 nF							•	•					•	•	•			
123	12 nF							•	•					•	•	•			
153	15 nF													•	•				
183	18 nF													•	•				
223	22 nF													•	•				
273	27 nF													•	•				
333	33 nF																		
393	39 nF																		
473	47 nF																		
563	56 nF																		

Notes

- Paper tape, • Plastic tape
- For soldering conditions see Vishay Soldering Recommendations [www.vishay.com/doc?45034](http://www.vishay.com/doc?45034)
- (1) Alternative product see GA...31M, GA...34G Automotive HIFREQ Series [www.vishay.com/doc?45248](http://www.vishay.com/doc?45248)



SELECTION CHART																
DIELECTRIC		X7R														
STYLE		VJ0402				VJ0603					VJ0805					
CASE CODE		0402				0603					0805					
VOLTAGE (V <sub>DC</sub> )		16	25	50	100	16	25	50	100	200	16	25	50	100	200	250
VOLTAGE CODE		J	X	A	B	J	X	A	B	C	J	X	A	B	C	P
CAP. CODE	CAP.															
121	120 pF	••	••	••	••											
151	150 pF	••	••	••	••											
181	180 pF	••	••	••	••											
221	220 pF	••	••	••	••											
271	270 pF	••	••	••	••											
331	330 pF	••	••	••	••			••	••	••	••	••	••	••	••	
391	390 pF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
471	470 pF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
561	560 pF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
681	680 pF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
821	820 pF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
102	1.0 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
122	1.2 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
152	1.5 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
182	1.8 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
222	2.2 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
272	2.7 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
332	3.3 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
392	3.9 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
472	4.7 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
562	5.6 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
682	6.8 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
822	8.2 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	
103	10 nF	••	••	••	••	••	••	••	••	••	••	••	••	••	••	••
123	12 nF	••	••			••	••	••	••	••	••	••	••	••	•	
153	15 nF	••	••			••	••	••	••	••	••	••	••	••	•	
183	18 nF	••	••			••	••	••	••	••	••	••	••	••	•	
223	22 nF	••				••	••	••	••	••	••	••	••	••	•	
273	27 nF	••				••	••	••	••	••	••	••	••	••	•	
333	33 nF	••				••	••	••	••	••	••	••	••	••	•	
393	39 nF					••	••	••	••	••	••	••	••	••	•	
473	47 nF					••	••	••	••	••	••	••	••	••	•	
563	56 nF					••	••	••	••	••	••	••	••	••	•	
683	68 nF					••	••	••	••	••	•	•	•	•	•	
823	82 nF					••	••	••	••	••	•	•	•	•	•	
104	100 nF					••	••	••	••	••	•	•	•	•	•	
124	120 nF					••					•	•	•			
154	150 nF					••					•	•	•			
184	180 nF										•	•				
224	220 nF										•	•				
274	270 nF										•	•				
334	330 nF										•	•				
394	390 nF										•					
474	470 nF										•					
564	560 nF															
684	680 nF															
824	820 nF															
105	1.0 μF															
125	1.2 μF															
155	1.5 μF															
185	1.8 μF															
225	2.2 μF															
275	2.7 μF															
335	3.3 μF															
395	3.9 μF															
475	4.7 μF															
565	5.6 μF															
685	6.8 μF															

Notes

- Paper tape, • Plastic tape
- For soldering conditions see Vishay Soldering Recommendations [www.vishay.com/doc?45034](http://www.vishay.com/doc?45034)



SELECTION CHART																						
DIELECTRIC		X7R																				
STYLE		VJ1206								VJ1210								VJ1812				
CASE CODE		1206								1210								1812				
VOLTAGE (V <sub>DC</sub> )		16	25	50	100	200	500	630	1000	16	25	50	100	200	500	630	50	100	200	500	630	
VOLTAGE CODE		J	X	A	B	C	E	L	G	J	X	A	B	C	E	L	A	B	C	E	L	
CAP. CODE	CAP.																					
121	120 pF																					
151	150 pF																					
181	180 pF																					
221	220 pF						•	•														
271	270 pF						•	•														
331	330 pF						•	•														
391	390 pF						•	•														
471	470 pF						•	•						•	•							
561	560 pF						•	•						•	•							
681	680 pF						•	•						•	•							
821	820 pF			•	•	•	•	•						•	•							
102	1.0 nF	•	•	•	•	•	•	•	•					•	•							
122	1.2 nF	•	•	•	•	•	•	•						•	•							
152	1.5 nF	•	•	•	•	•	•	•						•	•							
182	1.8 nF	•	•	•	•	•	•	•						•	•							
222	2.2 nF	•	•	•	•	•	•	•						•	•	•						
272	2.7 nF	•	•	•	•	•	•	•						•	•	•						
332	3.3 nF	•	•	•	•	•	•	•						•	•	•						
392	3.9 nF	•	•	•	•	•	•	•						•	•	•						
472	4.7 nF	•	•	•	•	•	•	•						•	•	•						
562	5.6 nF	•	•	•	•	•	•	•						•	•	•						
682	6.8 nF	•	•	•	•	•	•	•						•	•	•						
822	8.2 nF	•	•	•	•	•	•	•						•	•	•						
103	10 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
123	12 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
153	15 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
183	18 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
223	22 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•	•		•	•	•	
273	27 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
333	33 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
393	39 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
473	47 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
563	56 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
683	68 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
823	82 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
104	100 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
124	120 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
154	150 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
184	180 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
224	220 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
274	270 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
334	330 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
394	390 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
474	470 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
564	560 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
684	680 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
824	820 nF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
105	1.0 μF	•	•	•	•	•	•	•		•	•	•	•	•	•	•			•	•	•	
125	1.2 μF																					
155	1.5 μF																					
185	1.8 μF																					
225	2.2 μF																					
275	2.7 μF																					
335	3.3 μF																					
395	3.9 μF																					
475	4.7 μF																					
565	5.6 μF																					
685	6.8 μF																					

**Notes**

- Plastic tape
- For soldering conditions see Vishay Soldering Recommendations [www.vishay.com/doc?45034](http://www.vishay.com/doc?45034)



SELECTION CHART														
DIELECTRIC		X8R												
STYLE		VJ0402			VJ0603			VJ0805			VJ1206		VJ1210	
CASE CODE		0402			0603			0805			1206		1210	
VOLTAGE (V <sub>DC</sub> )		25	50	100	25	50	100	25	50	100	25	50	25	50
VOLTAGE CODE		X	A	B	X	A	B	X	A	B	X	A	X	A
CAP. CODE	CAP.													
101	100 pF													
121	120 pF													
151	150 pF													
181	180 pF													
221	220 pF													
271	270 pF													
331	330 pF	••	••	••										
391	390 pF	••	••	••										
471	470 pF	••	••	••		••	••	••	••	••				
561	560 pF	••	••	••		••	••	••	••	••				
681	680 pF	••	••	••	••	••	••	••	••	••				
821	820 pF	••	••	••	••	••	••	••	••	••				
102	1.0 nF	••	••	••	••	••	••	••	••	••	•	•		
122	1.2 nF	••	••	••	••	••	••	••	••	••	•	•		
152	1.5 nF	••	••		••	••	••	••	••	••	•	•		
182	1.8 nF	••	••		••	••	••	••	••	••	•	•		
222	2.2 nF	••	••		••	••	••	••	••	••	•	•		
272	2.7 nF	••			••	••	••	••	••	••	•	•		
332	3.3 nF	••			••	••	••	••	••	••	•	•		
392	3.9 nF	••			••	••	••	••	••	••	•	•		
472	4.7 nF	••			••	••	••	••	••	••	•	•		
562	5.6 nF	••			••	••		••	••	••	•	•		
682	6.8 nF	••			••	••		••	••	••	•	•		
822	8.2 nF				••	••		••	••	••	•	•		
103	10 nF				••	••		••	••	••	•	•	•	•
123	12 nF				••	••		••	••	••	•	•	•	•
153	15 nF				••	••		••	••	••	•	•	•	•
183	18 nF				••	••		••	••	••	•	•	•	•
223	22 nF				••			••	••	•	•	•	•	•
273	27 nF				••			••	•	•	•	•	•	•
333	33 nF				••			••	•		•	•	•	•
393	39 nF							••	•		•	•	•	•
473	47 nF							•	•		•	•	•	•
563	56 nF							•	•		•	•	•	•
683	68 nF							•			•	•	•	•
823	82 nF							•			•	•	•	•
104	100 nF							•			•	•	•	•
124	120 nF										•	•	•	•
154	150 nF										•		•	•
184	180 nF										•		•	
224	220 nF										•		•	
274	270 nF													
334	330 nF													
394	390 nF													
474	470 nF													
564	560 nF													
684	680 nF													
824	820 nF													
105	1.0 μF													
125	1.2 μF													

Notes

- Paper tape, • Plastic tape
- For soldering conditions see Vishay Soldering Recommendations [www.vishay.com/doc?45034](http://www.vishay.com/doc?45034)



STANDARD PACKAGING QUANTITIES (1)(2)					
CASE CODE	TAPE SIZE	7" REEL QUANTITIES		11 1/4" AND 13" REEL QUANTITIES	
		PAPER TAPE PACKAGING CODE "C"	PLASTIC TAPE PACKAGING CODE "T"	PAPER TAPE PACKAGING CODE "P"	PLASTIC TAPE PACKAGING CODE "R"
0402	8 mm	5000 / 10 000 <sup>(3)</sup>	n/a	10 000 / 30 000 <sup>(3)</sup>	n/a
0603 <sup>(5)</sup>	8 mm	4000	4000	10 000	10 000
0805 <sup>(4)(5)</sup>	8 mm	3000	3000	10 000	10 000
1206 <sup>(4)(5)</sup>	8 mm	3000	2500 / 3000	10 000	10 000
1210 <sup>(4)</sup>	8 mm	n/a	2000 / 2500 / 3000	n/a	9000 / 10 000
1812	12 mm	n/a	1000	n/a	4000

**Notes**

- (1) Reference: EIA standard RS 481 - "Taping of Surface Mount Components for Automatic Placement"
- (2) n/a = not available
- (3) Quantity can vary with customer request
- (4) Packaging "C" / "P" or "T" / "R" and quantity can depend from product thickness
- (5) Polymer termination, code "B", only available in plastic tape "T" / "R"



**1 - GENERAL CERTIFICATES**

# Quality management system according to ISO/IATF 16949: 2016	Yes
# Quality management system according to ISO 9001: 2015	Yes
# Environmental certification according to ISO 14001: 2015	Yes
# Health and safety system according to OSHA 18001	Yes

**2 - TECHNICAL REQUIREMENTS**

Unless specified in component specification, these parameters are the minimum requirements for the components.

**2.1 OPERATING TEMPERATURE RANGE**

For standard applications	T <sub>A</sub> : -55 °C to +125 °C	See characteristics 2.2
For high temperature applications	T <sub>A</sub> : -55 °C to +150 °C	See characteristics 2.2
For ultra high temperature applications	T <sub>A</sub> : -55 °C to +175 °C	See characteristics 2.2

**2.2 CHARACTERISTICS**

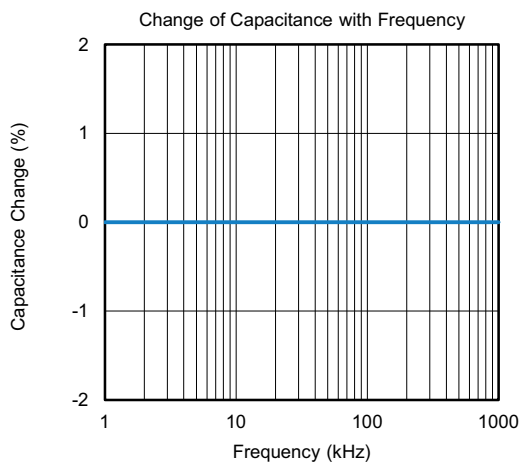
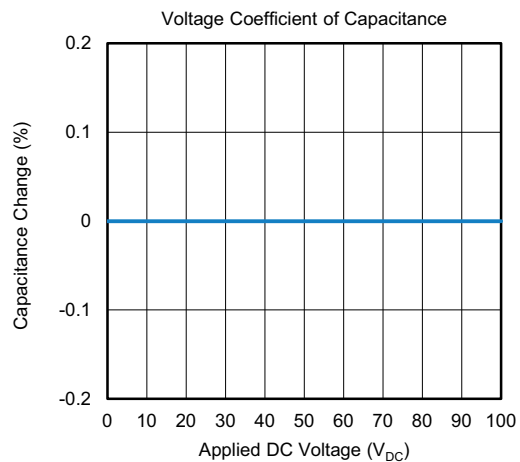
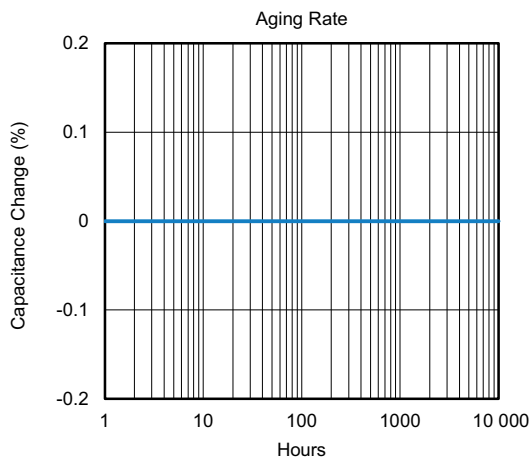
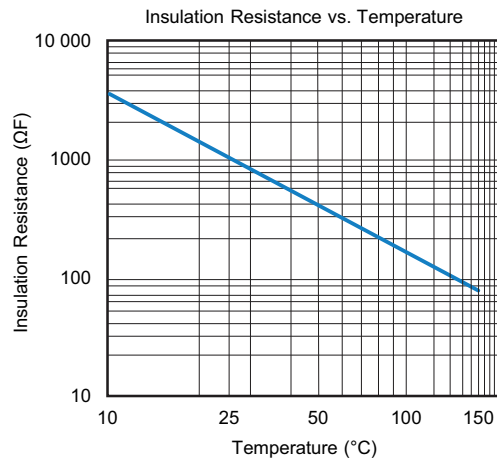
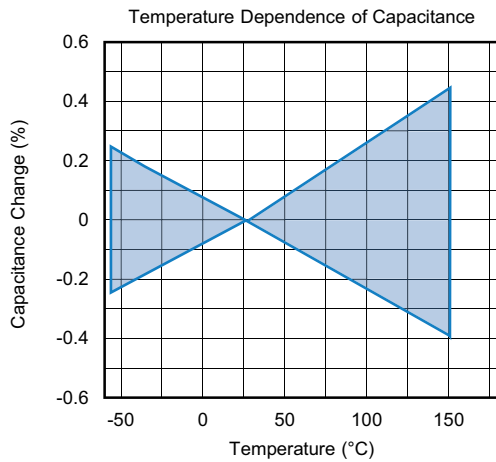
PARAMETER	CERAMIC TYPE	SYMBOL	RATINGS	TEST CONDITIONS / REMARKS
Rated voltage in temperature range -55 °C to +125 °C	C0G (NP0)	U <sub>R</sub>	25 V to 3000 V	
	X7R		16 V to 1000 V	
Rated voltage in temperature range -55 °C to +150 °C	X8R		25 V to 100 V	
Derating at higher temperature up to +150 °C	C0G (NP0)		25 V to 100 V	U <sub>DC</sub> ≤ 1/2 U <sub>R</sub>
	X7R		16 V to 100 V	U <sub>DC</sub> ≤ 1/2 U <sub>R</sub> U <sub>DC</sub> ≤ 1/4 U <sub>R</sub> for VJ0603Y104*A (100 nF / 50 V)
Derating at higher temperature up to +175 °C	C0G (NP0)		25 V to 100 V	U <sub>DC</sub> ≤ 1/4 U <sub>R</sub>
	X7R		16 V to 100 V	U <sub>DC</sub> ≤ 1/4 U <sub>R</sub>
	X8R		25 V to 100 V	U <sub>DC</sub> ≤ 1/4 U <sub>R</sub>
Temperature coefficient in temperature range -55 °C to +125 °C	C0G (NP0)	α <sub>C</sub>	≤ ± 30 ppm/°C	if C <sub>R</sub> < 10 pF: α <sub>C</sub> ≤ ± 120 ppm/°C
	X7R	ΔC	≤ ± 15 %	
Temperature coefficient in temperature range -55 °C to +150 °C	C0G (NP0)	α <sub>C</sub>	≤ ± 30 ppm/°C	if C <sub>R</sub> < 10 pF: α <sub>C</sub> ≤ ± 120 ppm/°C
	X7R	ΔC	+ 15 % / - 30 %	
	X8R		≤ ± 15 %	
Temperature coefficient in temperature range -55 °C to +175 °C	X7R	ΔC	+ 15 % / - 50 %	
Dissipation factor in temperature range -55 °C to +175 °C	C0G (NP0)	tan δ	≤ 0.0015	
	X7R		≤ 0.06	
	X8R		≤ 0.06	

**2.3 STORAGE AND HANDLING CONDITIONS**

(1) Store the components at 5 °C to 40 °C ambient temperature and ≤ 70 % relative humidity conditions.
(2) The product is recommended to be used within a time-frame of 2 years after shipment. Check solderability in case extended shelf life beyond the expiry date is needed.
Precautions:
a. Do not store products in an environment containing corrosive elements, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. This may cause corrosion or oxidization of the terminations, which can easily lead to poor soldering.
b. Store products on the shelf and avoid exposure to moisture or dust.
c. Do not expose products to excessive shock, vibration, direct sunlight and so on.

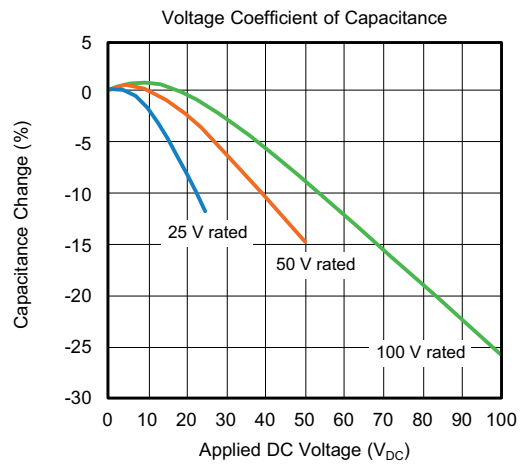
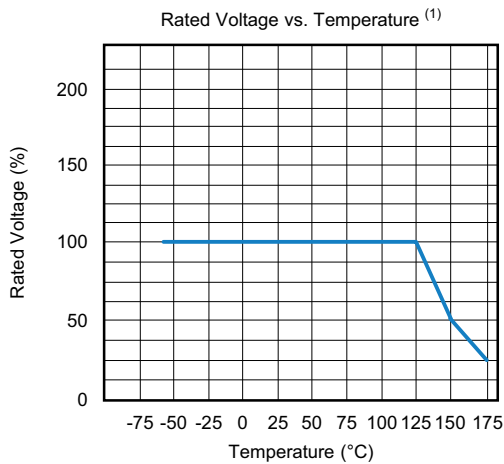
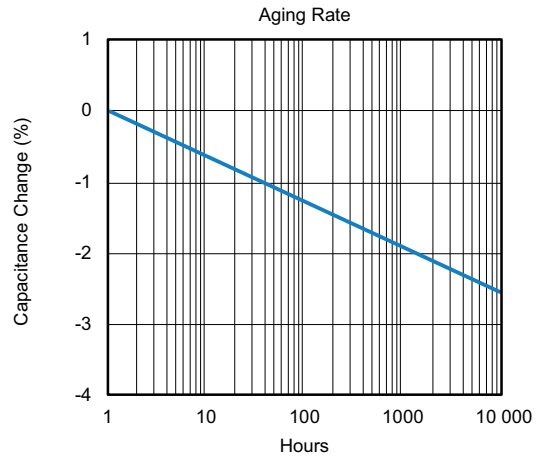
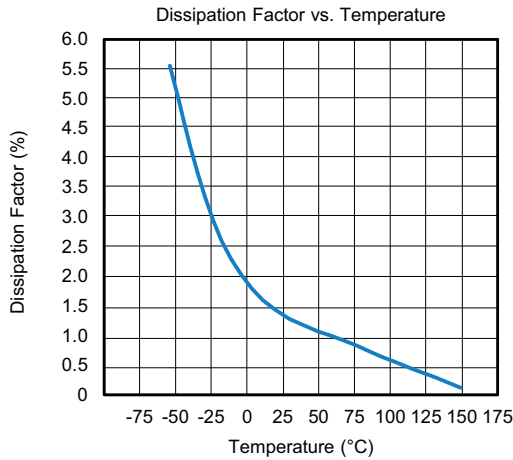
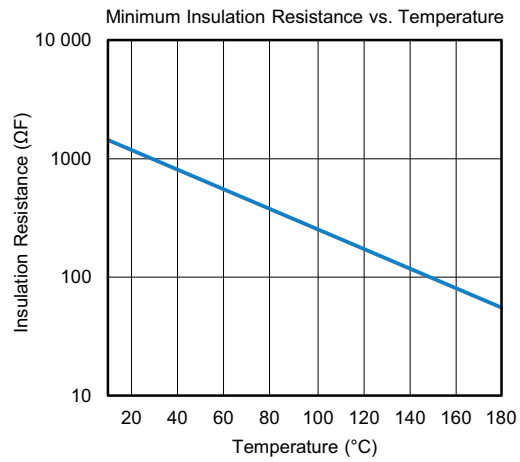
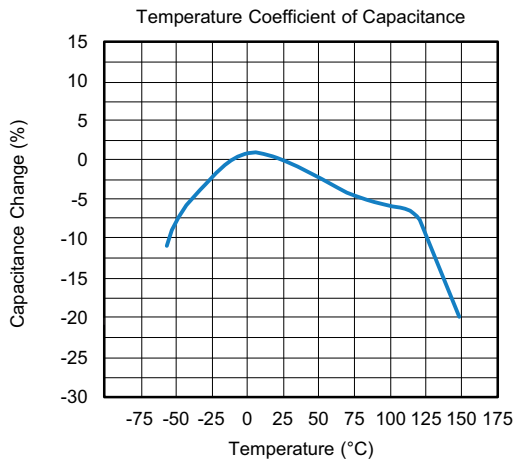


**COG (NP0) DIELECTRIC - TYPICAL PARAMETERS**





**X7R DIELECTRIC - TYPICAL PARAMETERS**

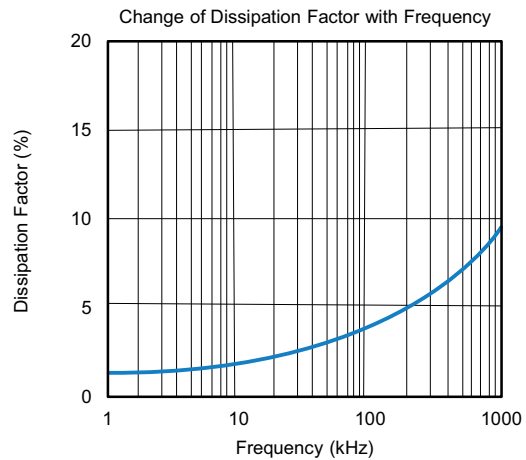
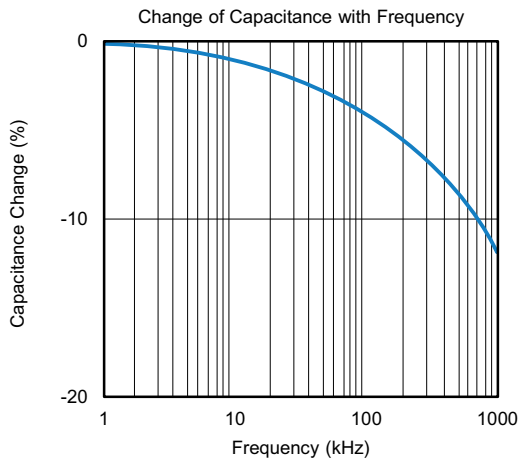
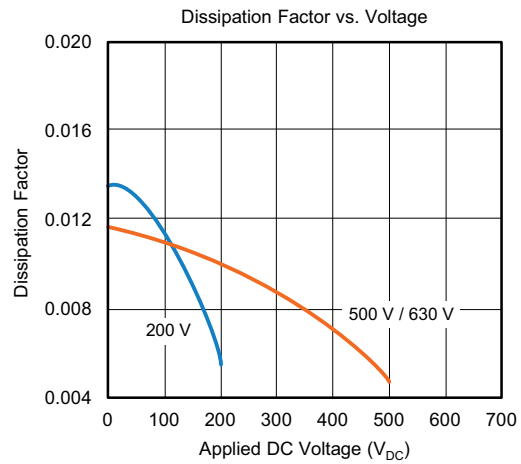
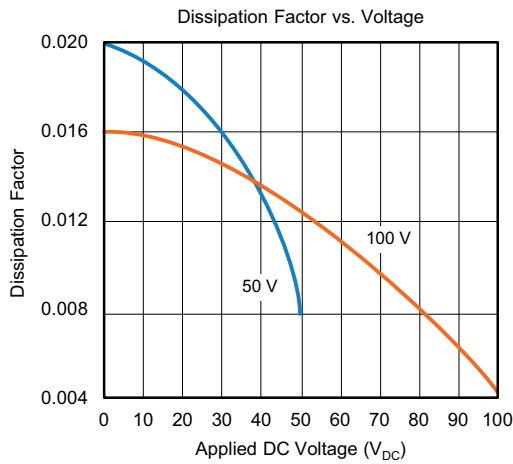


**Note**

<sup>(1)</sup> Except for VJ0603Y104\*A (100 nF / 50 V), see section "2.2 Characteristics"

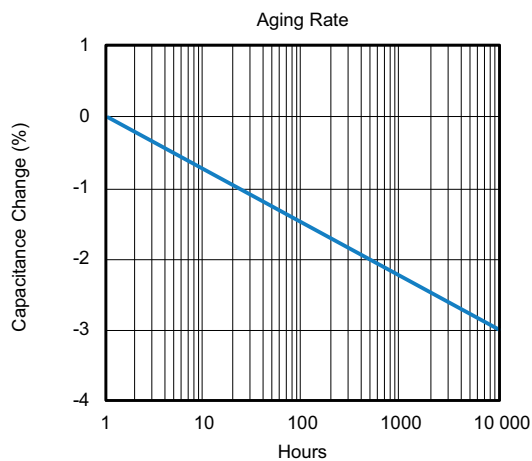
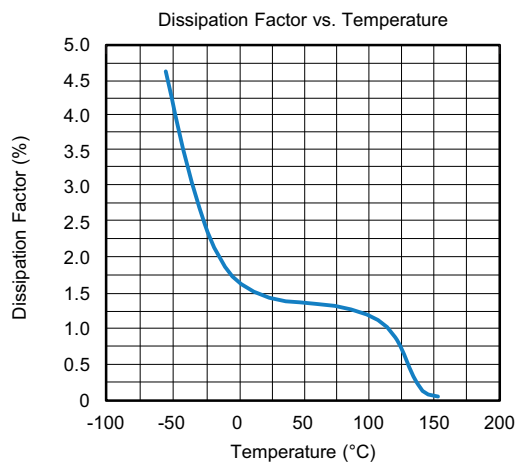
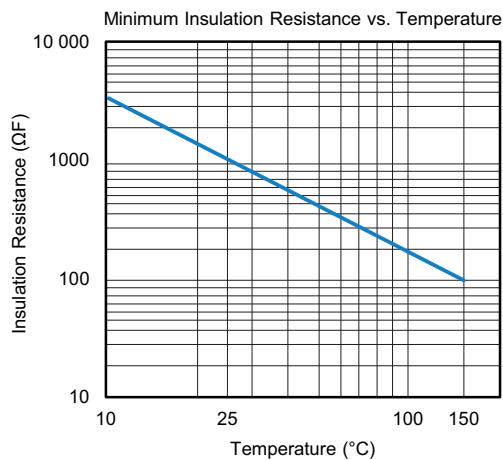
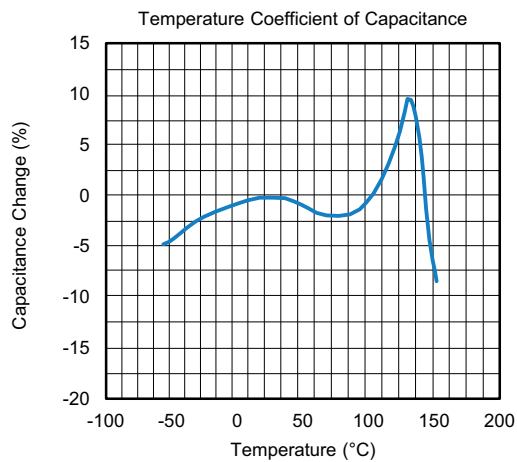


**X7R DIELECTRIC - TYPICAL PARAMETERS**





**X8R DIELECTRIC - TYPICAL PARAMETERS**





**3 - LOT ACCEPTANCE TESTS**

Process tests available in classes (on request)

GROUP	ACTION
A	Components are tested within the monitoring program of the supplier. The supplier shall submit the part numbers of the selected component to the customer during the component specification discussions.
B	Components (customer P/N) shall be tested quarterly. Records available only on special request by the customer.
C	Test with each shipment. Records are provided on a monthly basis. Customer special requirement; requirement should be determined in a specific component specification.

Upon request the records can be submitted in electronic format on monthly basis.

**3.1 THERMAL STRENGTH, THERMAL SHOCK SENSIBILITY**

Sample size	200
Handling	Mounted on PCB
Thermal shock	1 x 280 °C, no pre-heat, 5 s to 10 s
IR - test (IRATS)	U = U <sub>R</sub> , T = room temperature, verified
Burn in (BIATS)	Equivalent to 12 h burn-in, 2 x U <sub>R</sub> /125 °C, verification time to failure

Acceptance criteria: zero defects (IRATS and BIATS).

**3.2 BOARD FLEX TEST**

Sample size	20 pcs/lot
Frequency	At least three different part numbers of one component family matrix per quarter
Max. deflection	8 mm (data to be reported, available on request)

**3.3 SOLDERABILITY / RESISTANCE TO SOLDERING HEAT**

Temperature profile for reflow soldering of SMD parts IPC/JEDEC-J-STD-020C.

Test is done on a regular basis for samples taken randomly out of the line.

Acceptance criteria: at least 95 % new solder and no detachment or leaching of terminations.

**4 - ENVIRONMENTAL REQUIREMENTS**

A list of the chemical substances content, which must not be used or whose use shall be limited by international law, is available on request.

Vishay confirms that the components specified in this specification do not contain asbestos nor cadmium, not even in the smallest volumes.

The manufacturer / supplier confirms that the component during normal handling, storage and assembly, as well as during operation in the automobile, is non toxic.

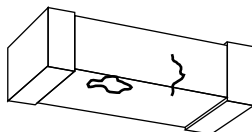


### 5 - INSPECTION CRITERIA

The supplier shall carry out visual examination with suitable equipment with approximately 10 x magnification and lighting appropriate to the specimen under test and the required quality level.

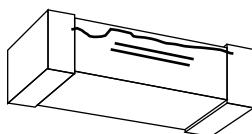
#### Chipping

The components shall be free of cracks or fissures. Small damages which do not deteriorate the performance of the component shall be less than 50 % of the surface of the MLCC as defined in EIA 595.



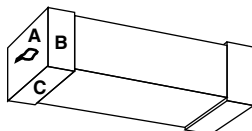
#### Delamination or Exposed Electrodes

No visible separation or delamination between layers of the capacitor and no exposed electrodes between the two terminals of the capacitor must be seen.



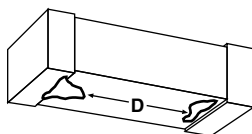
#### Metallization

For the metallization, no visible detachment of the metallized terminals and no exposed electrodes must be seen. Defects and gaps in the metallization on each sides of the terminal must not exceed 10 % of the total area (e.g. A, B, C, ...). Leaching shall not exceed 25 %.



#### Electrode Distance

The ceramic body shall be free of any conducting material between the terminals which reduces the distance of the electrodes. The minimum distance "D" is 400  $\mu\text{m}$  for all package sizes, except 0402. For the component package 0402 the minimum distance is 200  $\mu\text{m}$ .





## 6 - BOARD FLEX TEST CONDITIONS

### 6.1 BOARD FLEX DEFINITIONS OF TEST

PCB thickness =  $(1.6 \pm 0.1)$  mm

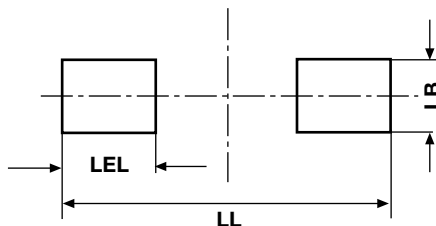
Copper thickness = 35  $\mu$ m

Material FR4 (EP-GC 02 according to DIN 40 802)

LAYOUT / PAD DESIGN (Dimensions in mm)			
CASE CODE	PAD SIZE		
	LL	LB	LEL
0603	2.20	1.00	0.75
0805	3.40	1.30	1.20
1206	4.50	1.80	1.20
1210	4.50	2.80	1.30
1812	4.75	3.60	1.50

#### Note

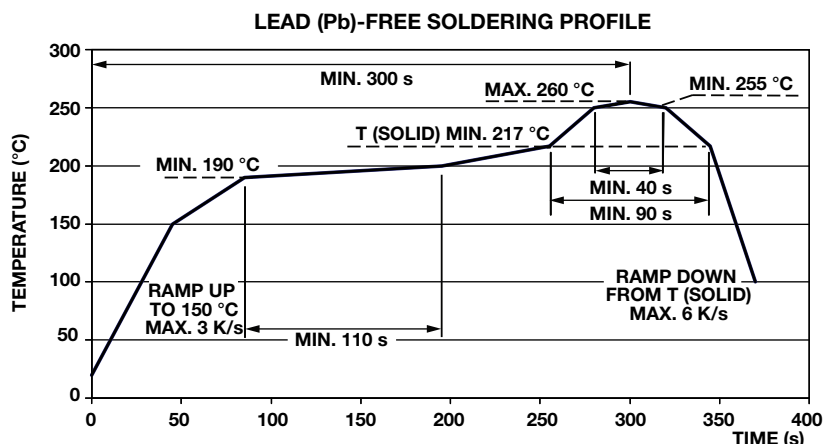
- LL = total length; LB = width of the pad; LEL = single pad length



### 6.2 SOLDERING INSTRUCTIONS

THICKNESS, RECOMMENDED FOR SOLDER PASTE (Reflow soldering)	
CASE CODE	THICKNESS in $\mu$ m
0402	75 to 90
0603	150 to 200
0805	150 to 200
1206	150 to 200
1210	150 to 200
1812	150 to 200

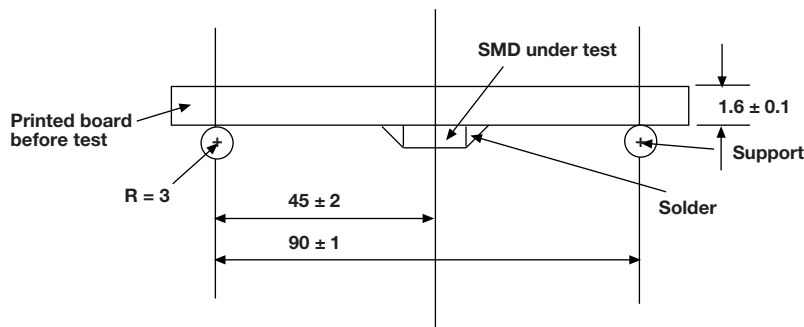
### 6.3 TYPICAL TEMPERATURE PROFILE FOR REFLOW SOLDERING (Boardflex test)



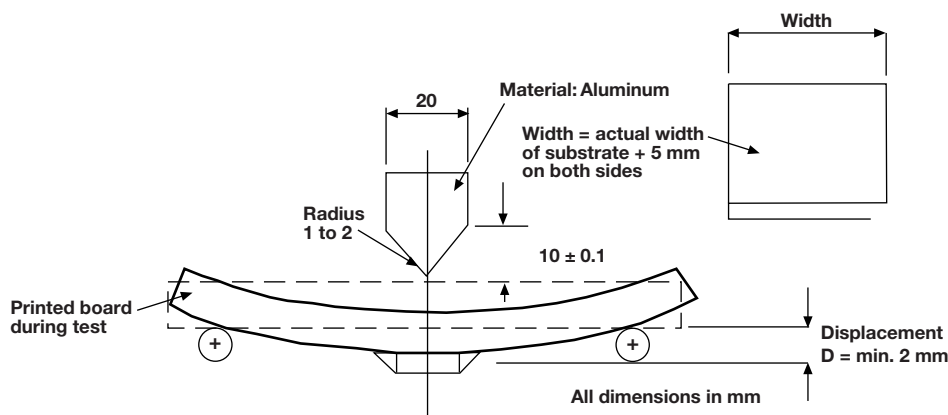


**6.4 MOUNTING, DIMENSIONS, AND TESTING**

**Mounting**



**Testing**



**6.5 PERFORMANCE OF THE TEST(S)**

- A) Electrical test according to component specification (Cap, DF, IR)
- B) Mounting to PCB
- C) Storage at room temperature (min. 10 h)
- D) Board flex test

**6.6 DETAILS**

X7R, X8R	PCB to be deflected continuously, speed 1 mm/s ( $\pm 0.5$ mm/s)
C0G	PCB to be deflected in steps until cracks or other damages are visible or can be measured. Dwell time between steps: $(5 \pm 1)$ s

**6.7 FAILURE CRITERIA**

X7R, X8R	Piezoelectric sensor, no failure up to min. 2 mm
C0G	$\Delta C/C < 1\%$ or $< 1$ pF, no failure up to min. 2 mm
Both	Electrical test according to component specification



**7 - AEC-Q200 QUALIFICATION TESTING**

NO.	AEC-Q200 TEST ITEM	REFERENCE
1	Pre- and post stress electrical test	User spec
3	High temp exposure (storage)	MIL-STD-202, method 108
4	Temperature cycling	JESD22, method JA-104
5	Destructive physical analysis	EIA-469
6	Moisture resistance	MIL-STD-202, method 106
7	Biased humidity	MIL-STD-202, method 103
8	Operation life	MIL-STD-202 method 108
9	External Visual	MIL-STD-883 method 2009
10	Physical dimension	JESD22, method JB-100
13	Mechanical shock	MIL-STD-202, method 213
14	Vibration	MIL-STD-202, method 204
15	Resistance to solder heat	MIL-STD-202, method 210
16	ESD	AEC-Q200-002
17	Solderability	J-STD-002
20	Electrical characterization	User spec
21	Board flex	AEC-Q200-005
22	Terminal strength	AEC-Q200-006
23	Beam load	AEC-Q200-003



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